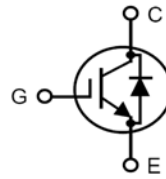


# XPT™ 650V IGBT GenX4™ w/ Sonic Diode

## IXXH60N65B4H1

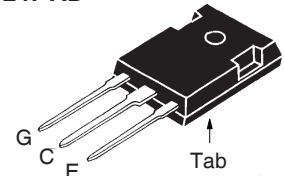


Extreme Light Punch Through  
IGBT for 5-30 kHz Switching

$$\begin{aligned} V_{CES} &= 650V \\ I_{C110} &= 60A \\ V_{CE(sat)} &\leq 2.0V \\ t_{fi(typ)} &= 72ns \end{aligned}$$

| Symbol                        | Test Conditions   | Maximum Ratings                           |                  |
|-------------------------------|---|---|------------------|
| $V_{CES}$                     | $T_J = 25^\circ\text{C}$ to $175^\circ\text{C}$   | 650                                       | V                |
| $V_{CGR}$                     | $T_J = 25^\circ\text{C}$ to $175^\circ\text{C}$ , $R_{GE} = 1M\Omega$                             | 650                                       | V                |
| $V_{GES}$                     | Continuous  | $\pm 20$                                  | V                |
| $V_{GEM}$                     | Transient   | $\pm 30$                                  | V                |
| $I_{C25}$                     | $T_C = 25^\circ\text{C}$ (Chip Capability)  | 116                                       | A                |
| $I_{C110}$                    | $T_C = 110^\circ\text{C}$   | 60  | A                |
| $I_{F110}$                    | $T_C = 110^\circ\text{C}$   | 48  | A                |
| $I_{CM}$                      | $T_C = 25^\circ\text{C}$ , 1ms  | 230                                       | A                |
| <b>SSOA</b><br><b>(RBSOA)</b> | $V_{GE} = 15V$ , $T_{VJ} = 150^\circ\text{C}$ , $R_G = 5\Omega$<br>Clamped Inductive Load         | $I_{CM} = 120$<br>@ $V_{CE} \leq V_{CES}$ | A                |
| $t_{sc}$<br><b>(SCSOA)</b>    | $V_{GE} = 15V$ , $V_{CE} = 360V$ , $T_J = 150^\circ\text{C}$<br>$R_G = 82\Omega$ , Non Repetitive | 10  | $\mu\text{s}$    |
| $P_C$                         | $T_C = 25^\circ\text{C}$  | 380                                       | W                |
| $T_J$                         |   | -55 ... +175                              | $^\circ\text{C}$ |
| $T_{JM}$                      |   | 175                                       | $^\circ\text{C}$ |
| $T_{stg}$                     |   | -55 ... +175                              | $^\circ\text{C}$ |
| $T_L$                         | Maximum Lead Temperature for Soldering  | 300                                       | $^\circ\text{C}$ |
| $T_{SOLD}$                    | 1.6 mm (0.062in.) from Case for 10s   | 260                                       | $^\circ\text{C}$ |
| $M_d$                         | Mounting Torque   | 1.13/10                                   | Nm/lb.in.        |
| <b>Weight</b>                 |   | 6   | g                |

### TO-247 AD



G = Gate      C = Collector  
E = Emitter    Tab = Collector

### Features

- Optimized for 5-30kHz Switching
- Square RBSOA
- Anti-Parallel Sonic Diode
- Short Circuit Capability
- International Standard Package

### Advantages

- High Power Density
- Extremely Rugged
- Low Gate Drive Requirement

### Applications

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts

| Symbol        | Test Conditions<br>( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified) | Characteristic Values |            |                          |
|---------------|---|-----------------------|------------|--------------------------|
|               |   | Min.                  | Typ.       | Max.                     |
| $BV_{CES}$    | $I_C = 250\mu\text{A}$ , $V_{GE} = 0V$                                      | 650                   |            | V                        |
| $V_{GE(th)}$  | $I_C = 250\mu\text{A}$ , $V_{CE} = V_{GE}$                                  | 4.0                   |            | 6.5 V                    |
| $I_{CES}$     | $V_{CE} = V_{CES}$ , $V_{GE} = 0V$<br>$T_J = 150^\circ\text{C}$             |                       |            | 25 $\mu\text{A}$<br>3 mA |
| $I_{GES}$     | $V_{CE} = 0V$ , $V_{GE} = \pm 20V$  |                       |            | $\pm 100$ nA             |
| $V_{CE(sat)}$ | $I_C = 60A$ , $V_{GE} = 15V$ , Note 1<br>$T_J = 150^\circ\text{C}$          |                       | 1.7<br>2.2 | V<br>V                   |

| Symbol       | Test Conditions<br>( $T_J = 25^\circ\text{C}$ Unless Otherwise Specified)   | Characteristic Values |      |                           |
|--------------|---|-----------------------|------|---------------------------|
|              |   | Min.                  | Typ. | Max.                      |
| $g_{fs}$     | $I_C = 60\text{A}, V_{CE} = 10\text{V}$ , Note 1  | 13                    | 22   | S                         |
| $C_{ies}$    | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$  |                       | 1890 | pF                        |
| $C_{oes}$    |   |                       | 223  | pF                        |
| $C_{res}$    |   |                       | 70   | pF                        |
| $Q_{g(on)}$  | $I_C = 60\text{A}, V_{GE} = 15\text{V}, V_{CE} = 0.5 \cdot V_{CES}$   |                       | 95   | nC                        |
| $Q_{ge}$     |   |                       | 17   | nC                        |
| $Q_{gc}$     |   |                       | 39   | nC                        |
| $t_{d(on)}$  | <b>Inductive load, <math>T_J = 25^\circ\text{C}</math></b><br>$I_C = 60\text{A}, V_{GE} = 15\text{V}$<br>$V_{CE} = 400\text{V}, R_G = 5\Omega$<br>Note 2  |                       | 37   | ns                        |
| $t_{ri}$     |   |                       | 80   | ns                        |
| $E_{on}$     |   |                       | 3.13 | mJ                        |
| $t_{d(off)}$ |   |                       | 145  | ns                        |
| $t_{fi}$     |   |                       | 72   | ns                        |
| $E_{off}$    |   |                       | 1.15 | 1.75 mJ                   |
| $t_{d(on)}$  | <b>Inductive load, <math>T_J = 150^\circ\text{C}</math></b><br>$I_C = 60\text{A}, V_{GE} = 15\text{V}$<br>$V_{CE} = 400\text{V}, R_G = 5\Omega$<br>Note 2 |                       | 32   | ns                        |
| $t_{ri}$     |   |                       | 73   | ns                        |
| $E_{on}$     |   |                       | 3.42 | mJ                        |
| $t_{d(off)}$ |   |                       | 126  | ns                        |
| $t_{fi}$     |   |                       | 94   | ns                        |
| $E_{off}$    |   |                       | 1.34 | mJ                        |
| $R_{thJC}$   |   |                       | 0.33 | $^\circ\text{C}/\text{W}$ |
| $R_{thCS}$   |   | 0.21                  |      | $^\circ\text{C}/\text{W}$ |

TO-247 (IXXH) Outline



Terminals: 1 - Gate 2 - Collector 3 - Emitted

| Dim.           | Millimeter |       | Inches |       |
|----------------|------------|-------|--------|-------|
|                | Min.       | Max.  | Min.   | Max.  |
| A              | 4.7        | 5.3   | .185   | .209  |
| A <sub>1</sub> | 2.2        | 2.54  | .087   | .102  |
| A <sub>2</sub> | 2.2        | 2.6   | .059   | .098  |
| b              | 1.0        | 1.4   | .040   | .055  |
| b <sub>1</sub> | 1.65       | 2.13  | .065   | .084  |
| b <sub>2</sub> | 2.87       | 3.12  | .113   | .123  |
| C              | .4         | .8    | .016   | .031  |
| D              | 20.80      | 21.46 | .819   | .845  |
| E              | 15.75      | 16.26 | .610   | .640  |
| e              | 5.20       | 5.72  | 0.205  | 0.225 |
| L              | 19.81      | 20.32 | .780   | .800  |
| L1             |            | 4.50  |        | .177  |
| ∅P             | 3.55       | 3.65  | .140   | .144  |
| Q              | 5.89       | 6.40  | 0.232  | 0.252 |
| R              | 4.32       | 5.49  | .170   | .216  |
| S              | 6.15       | BSC   | 242    | BSC   |

### Reverse Sonic Diode (FRD)

| Symbol     | Test Conditions<br>( $T_J = 25^\circ\text{C}$ Unless Otherwise Specified)                     | Characteristic Values     |      |                                |
|------------|---|---------------------------|------|--------------------------------|
|            |   | Min.                      | Typ. | Max.                           |
| $V_F$      | $I_F = 50\text{A}, V_{GE} = 0\text{V}$ , Note 1   |                           | 1.8  | 2.0 V                          |
|            |   | $T_J = 150^\circ\text{C}$ |      | V                              |
| $I_{RM}$   | $I_F = 50\text{A}, V_{GE} = 0\text{V}, -di_F/dt = 900\text{A}/\mu\text{s}, V_R = 300\text{V}$ | $T_J = 150^\circ\text{C}$ | 45   | A                              |
| $t_{rr}$   |   | $T_J = 150^\circ\text{C}$ | 150  | ns                             |
| $R_{thJC}$ |   |                           |      | 0.62 $^\circ\text{C}/\text{W}$ |

Notes:

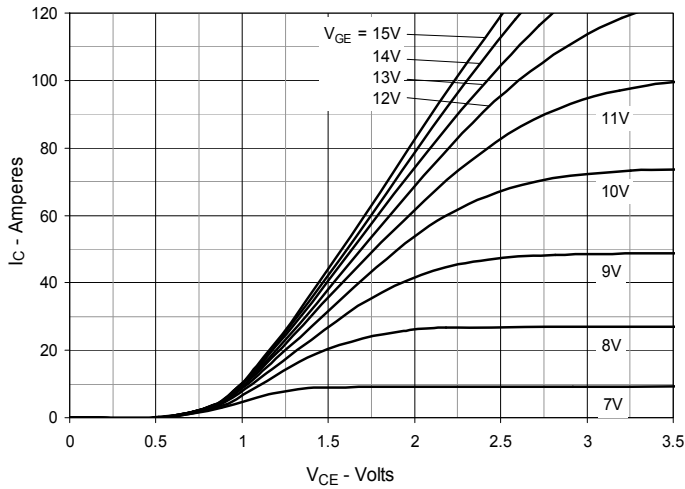
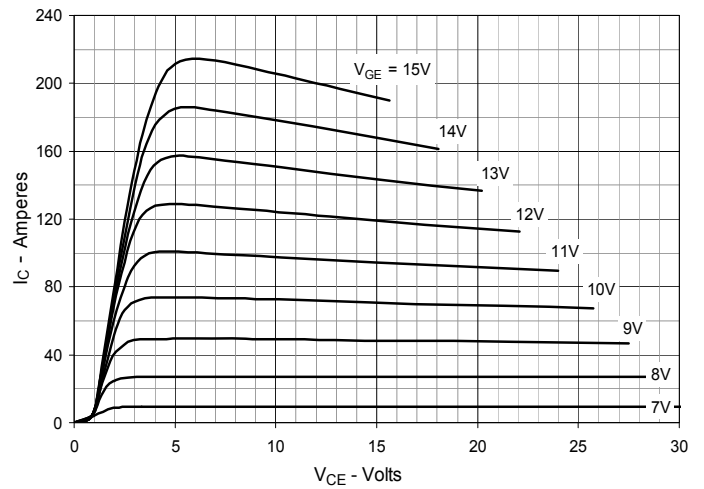
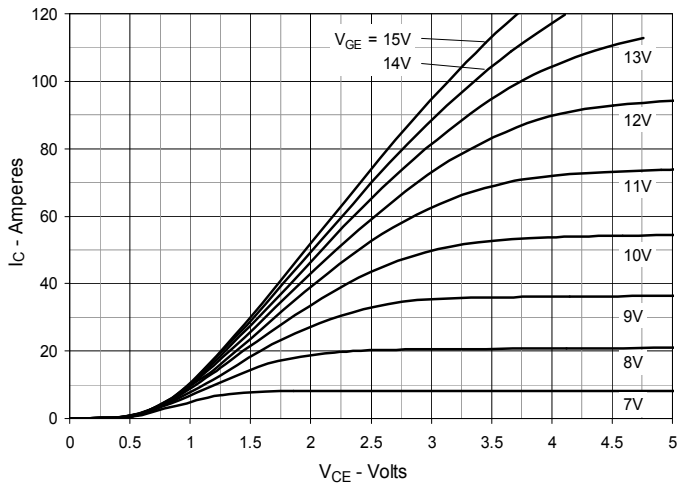
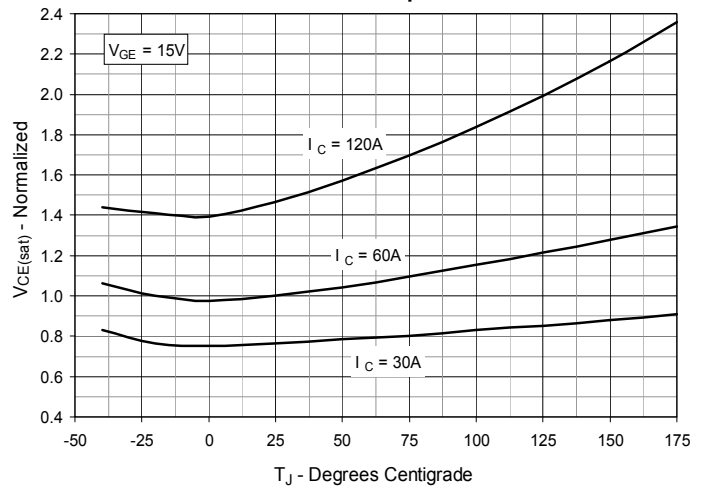
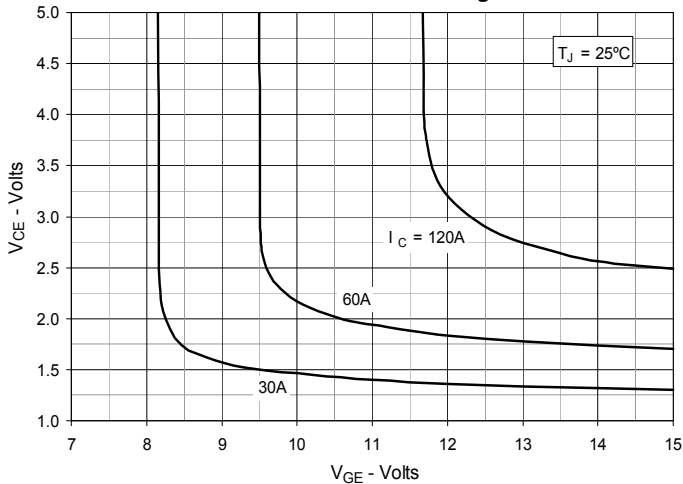
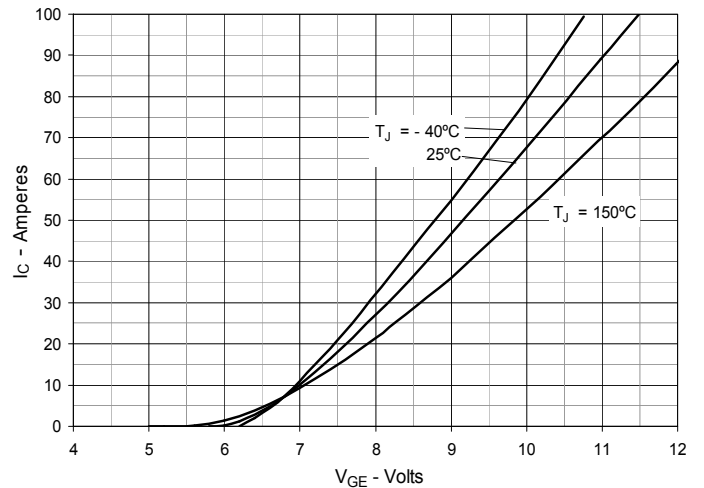
1. Pulse test,  $t \leq 300\mu\text{s}$ , duty cycle,  $d \leq 2\%$ .
2. Switching times & energy losses may increase for higher  $V_{CE}$  (clamp),  $T_J$  or  $R_G$ .

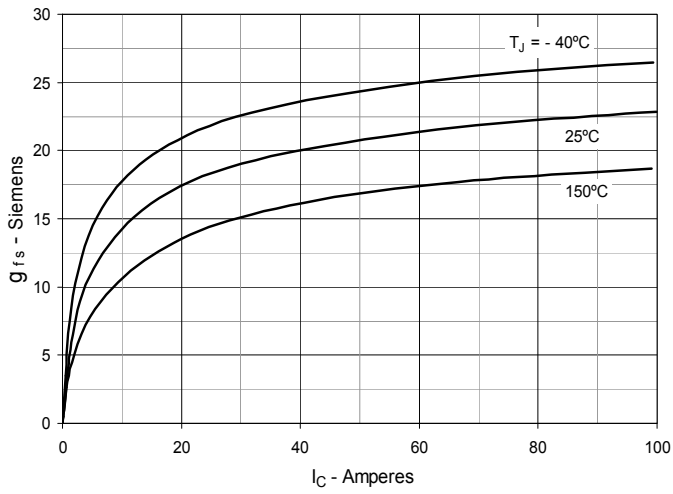
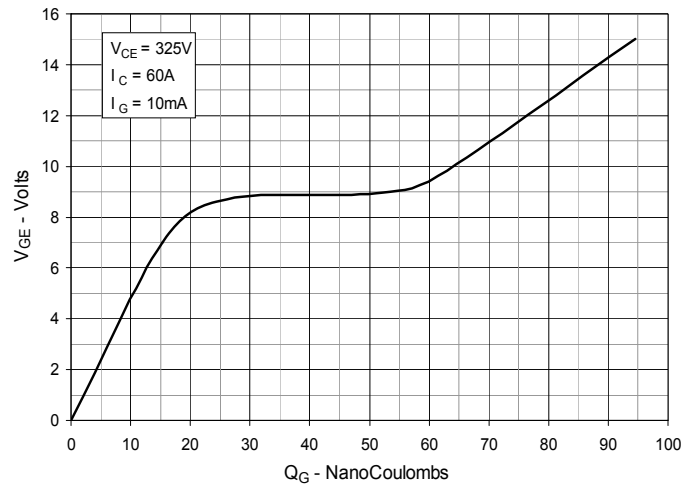
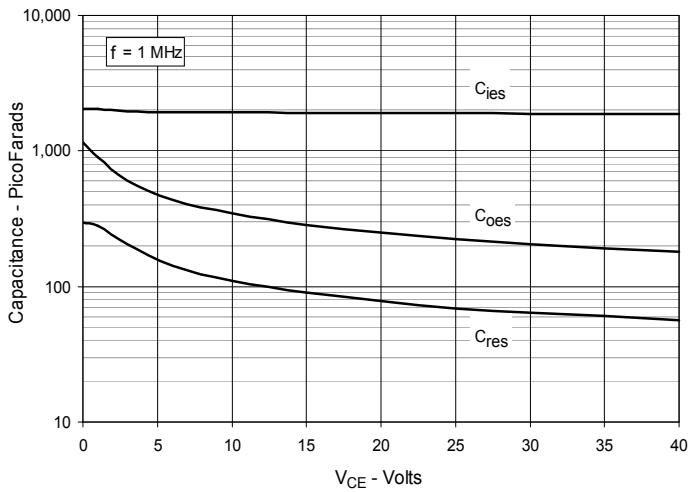
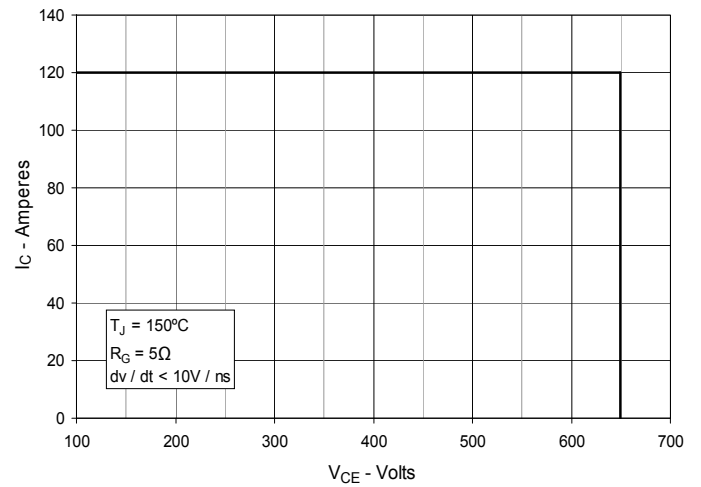
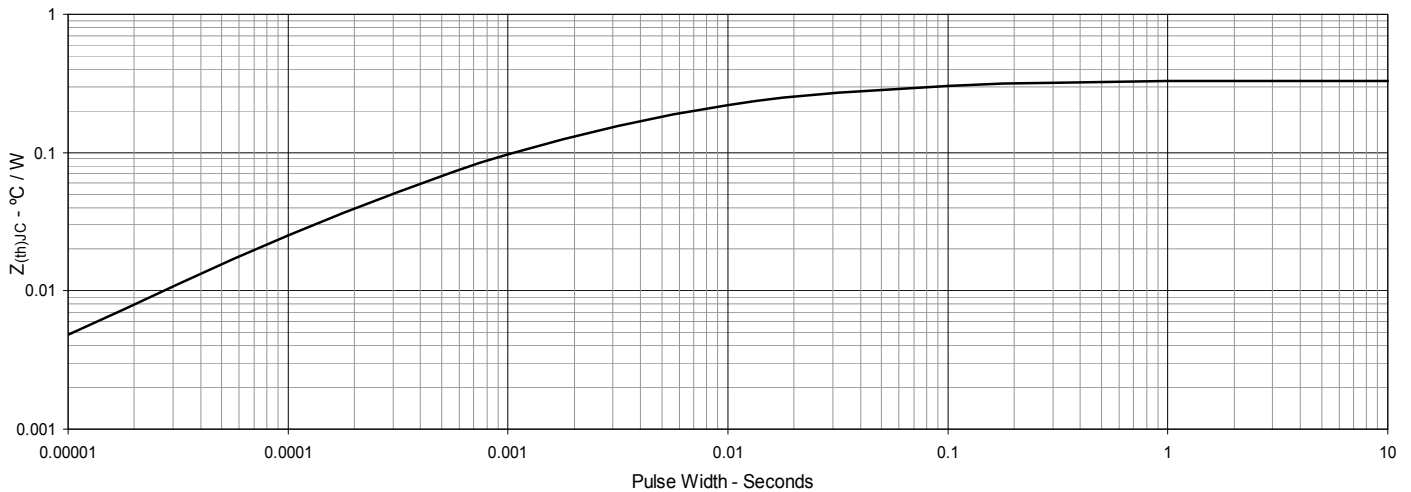
### PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

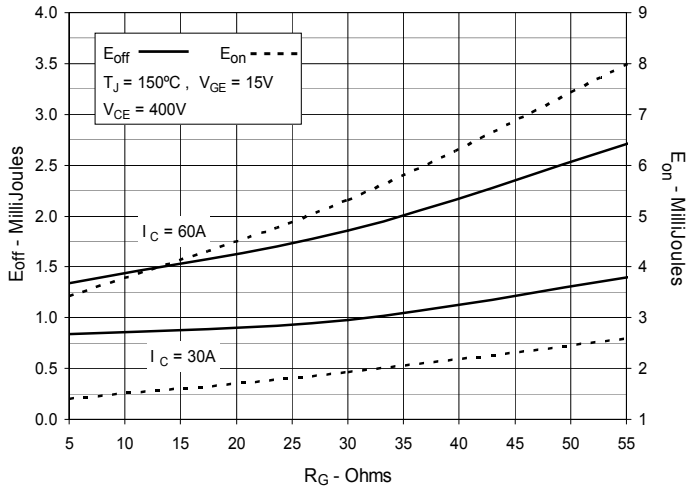
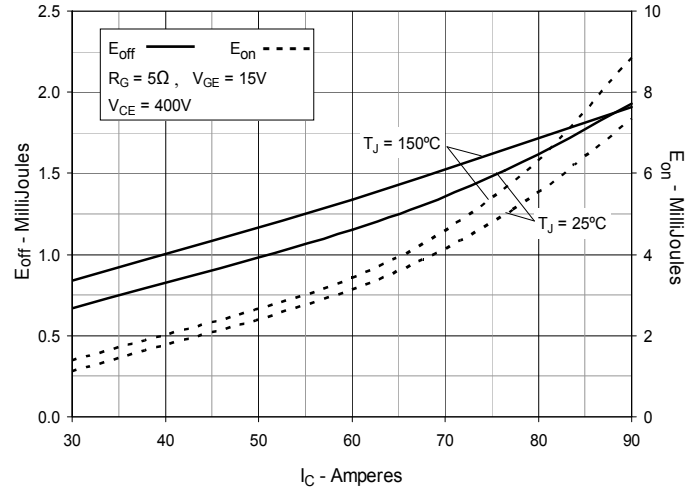
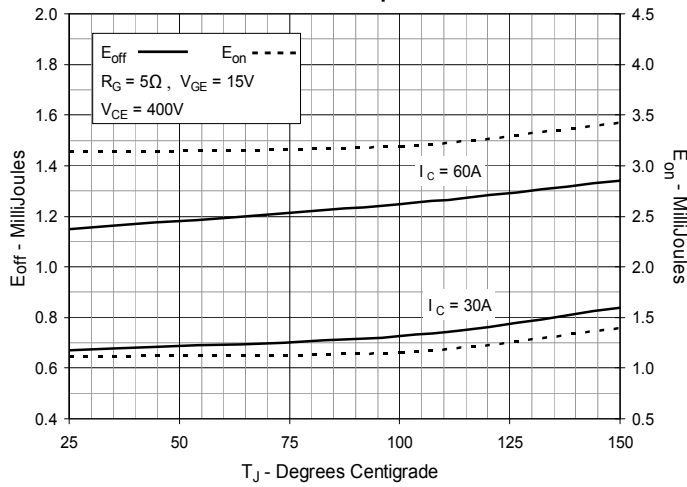
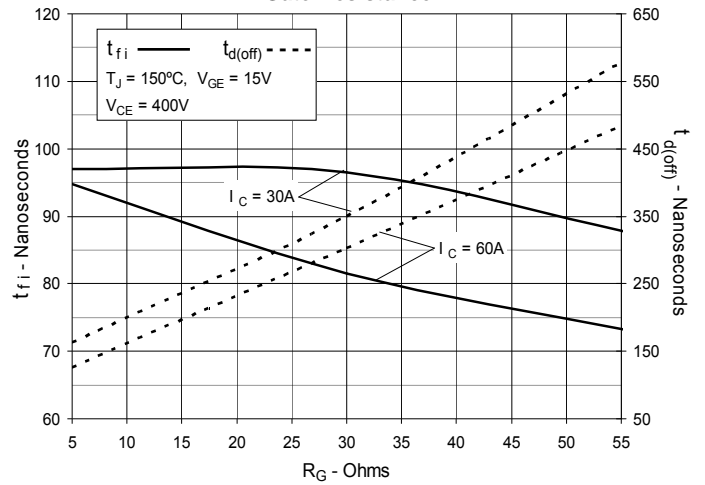
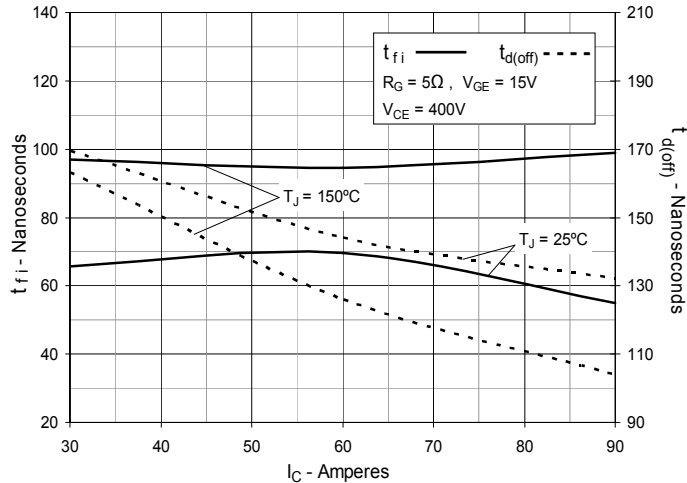
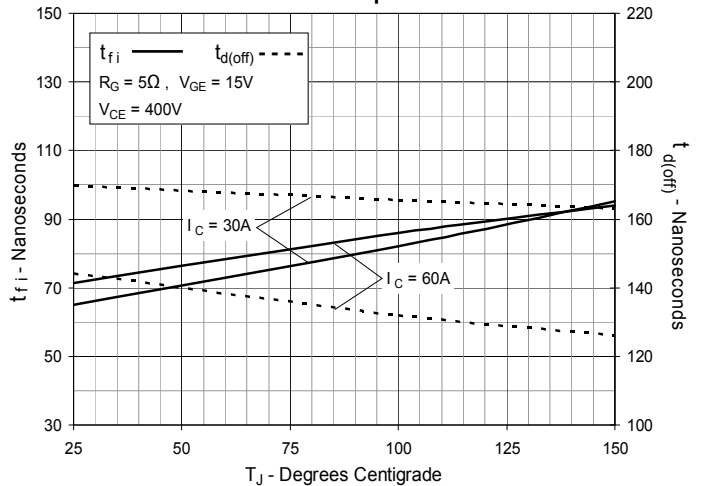
IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

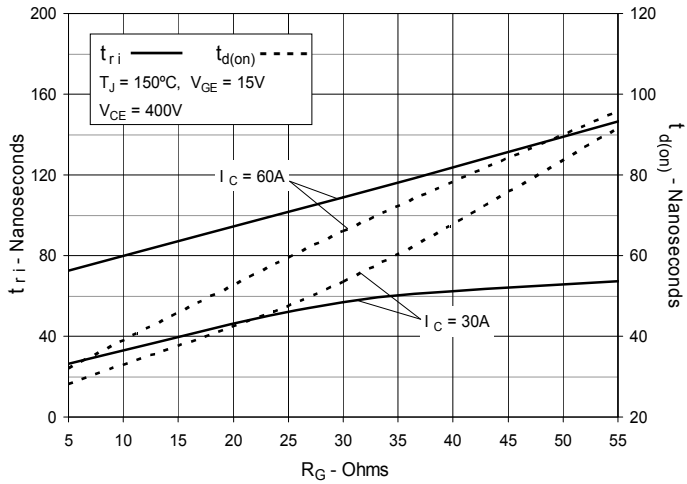
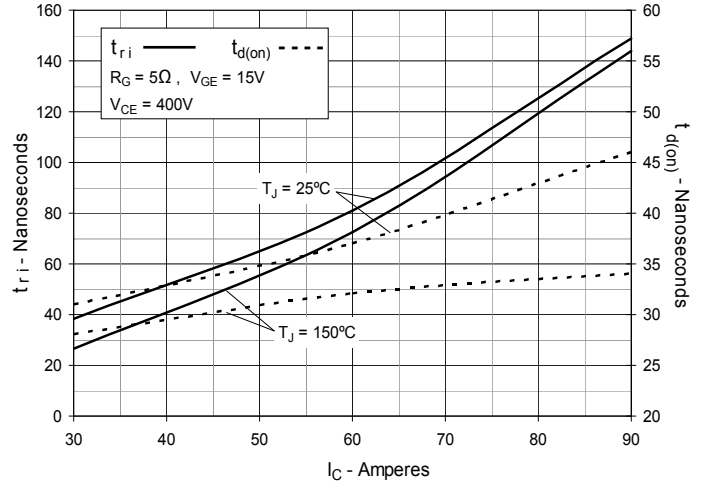
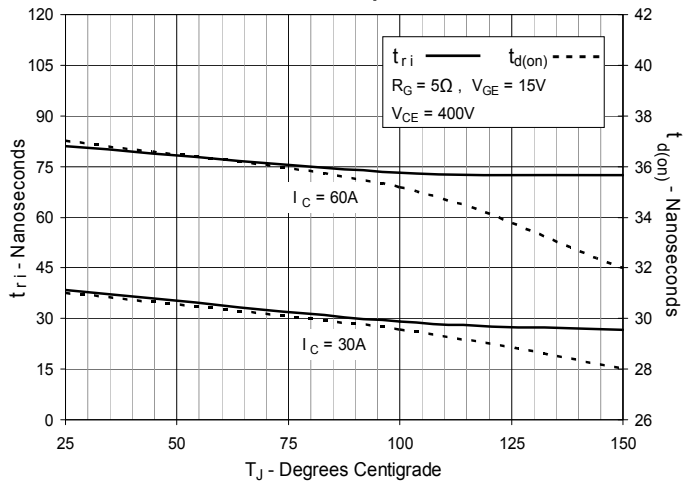
|  |           |           |           |           |              |              |              |              |              |             |
|--|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|-------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665    | 6,404,065 B1 | 6,683,344    | 6,727,585    | 7,005,734 B2 | 7,157,338B2 |
|  | 4,860,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343    | 6,710,405 B2 | 6,759,692    | 7,063,975 B2 |             |
|  | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505    | 6,710,463    | 6,771,478 B2 | 7,071,537    |             |

**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 3. Output Characteristics @  $T_J = 150^\circ\text{C}$** 

**Fig. 4. Dependence of  $V_{CE(sat)}$  on Junction Temperature**

**Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage**

**Fig. 6. Input Admittance**


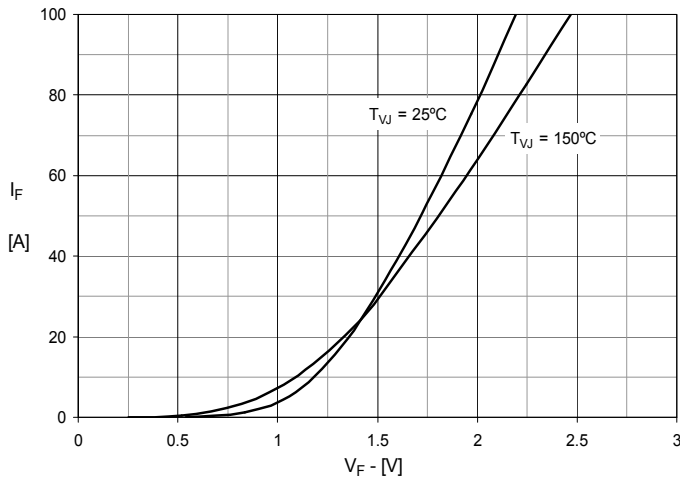
**Fig. 7. Transconductance**

**Fig. 8. Gate Charge**

**Fig. 9. Capacitance**

**Fig. 10. Reverse-Bias Safe Operating Area**

**Fig. 11. Maximum Transient Thermal Impedance**


IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

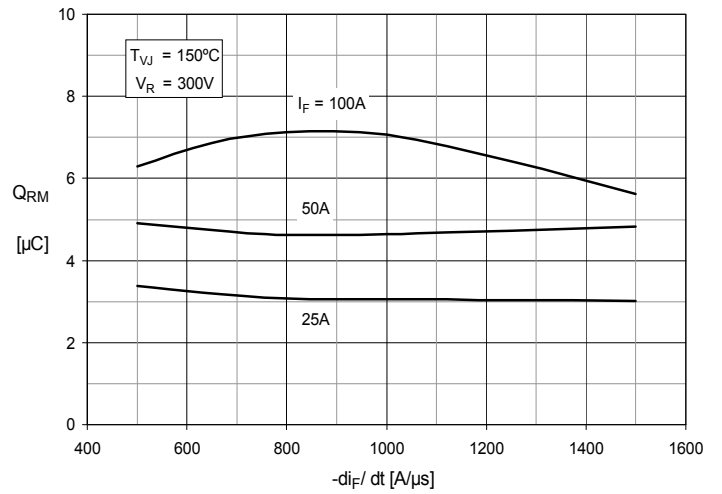
**Fig. 12. Inductive Switching Energy Loss vs. Gate Resistance**

**Fig. 13. Inductive Switching Energy Loss vs. Collector Current**

**Fig. 14. Inductive Switching Energy Loss vs. Junction Temperature**

**Fig. 15. Inductive Turn-off Switching Times vs. Gate Resistance**

**Fig. 16. Inductive Turn-off Switching Times vs. Collector Current**

**Fig. 17. Inductive Turn-off Switching Times vs. Junction Temperature**


**Fig. 18. Inductive Turn-on Switching Times vs. Gate Resistance**

**Fig. 19. Inductive Turn-on Switching Times vs. Collector Current**

**Fig. 20. Inductive Turn-on Switching Times vs. Junction Temperature**


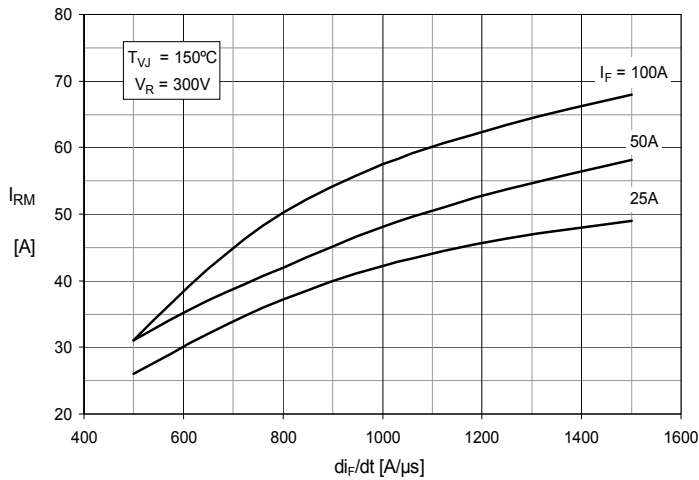
**Fig. 21. Typ. Forward characteristics**



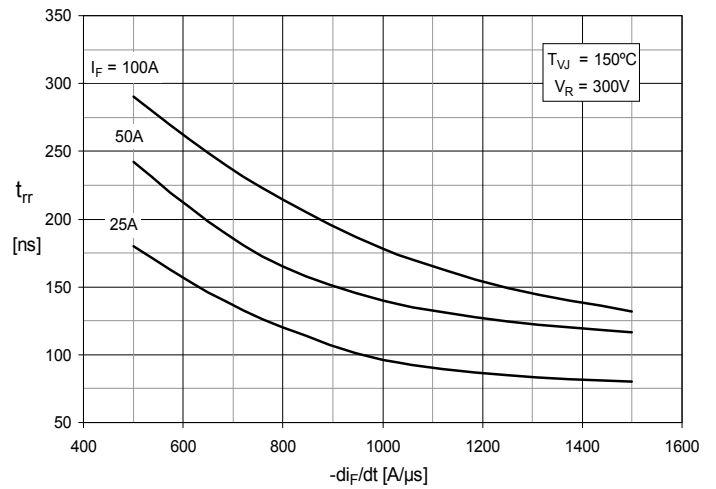
**Fig. 22. Typ. Reverse Recovery Charge  $Q_{rr}$  vs.  $-di_F/dt$**



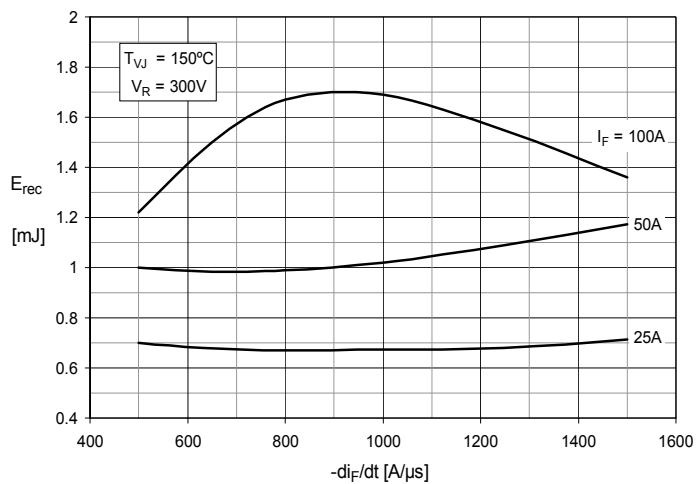
**Fig. 23. Typ. Peak Reverse Current  $I_{RM}$  vs.  $-di_F/dt$**



**Fig. 24. Typ. Recovery Time  $t_{rr}$  vs.  $-di_F/dt$**



**Fig. 25. Typ. Recovery Energy  $E_{rec}$  vs.  $-di_F/dt$**



**Fig. 26. Maximum Transient Thermal Impedance**

